NPN power transistor with integrated diode Rev. 02 — 29 July 2010

Product data sheet

Product profile 1.

1.1 General description

High voltage, high speed, planar passivated NPN power switching transistor with integrated anti-parallel E-C diode in a SOT78 plastic package.

1.2 Features and benefits

- Fast switching
- High voltage capability

1.3 Applications

- Integrated fluorescent lamp ballasts e.g. high power cluster lamps
- Low Voltage Tungsten Halogen transformers

- Integrated anti-parallel E-C diode
- Low thermal resistance
- Remote fluorescent lamp ballasts
- Self Oscillating Power Supplies

1.4 Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
I _C	collector current	see <u>Figure 1</u> ; see <u>Figure 2</u> ; see <u>Figure 4</u> ; DC	-	-	4	A
P _{tot}	total power dissipation	see <mark>Figure 3</mark> ; T _{mb} ≤ 25 °C	-	-	75	W
V _{CESM}	collector-emitter peak voltage	V _{BE} = 0 V	-	-	700	V
Static cha	racteristics					
h _{FE}	DC current gain	$V_{CE} = 5 \text{ V}; \text{ I}_{C} = 1.0 \text{ A};$ see <u>Figure 10</u>	12	20	40	
		$V_{CE} = 5 \text{ V}; I_C = 2.0 \text{ A};$ see Figure 10	10	17	28	



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2. Pinning information

Table 2.	Pinning	j information		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	В	base		2
2	С	collector	mb	C L
3	E	emitter		в-Г
mb	С	mounting base; connected to collector		E sym131

SOT78 (TO-220AB)

3. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
PHD13005	TO-220AB	plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB	SOT78

4. Limiting values

Table 4.Limiting values

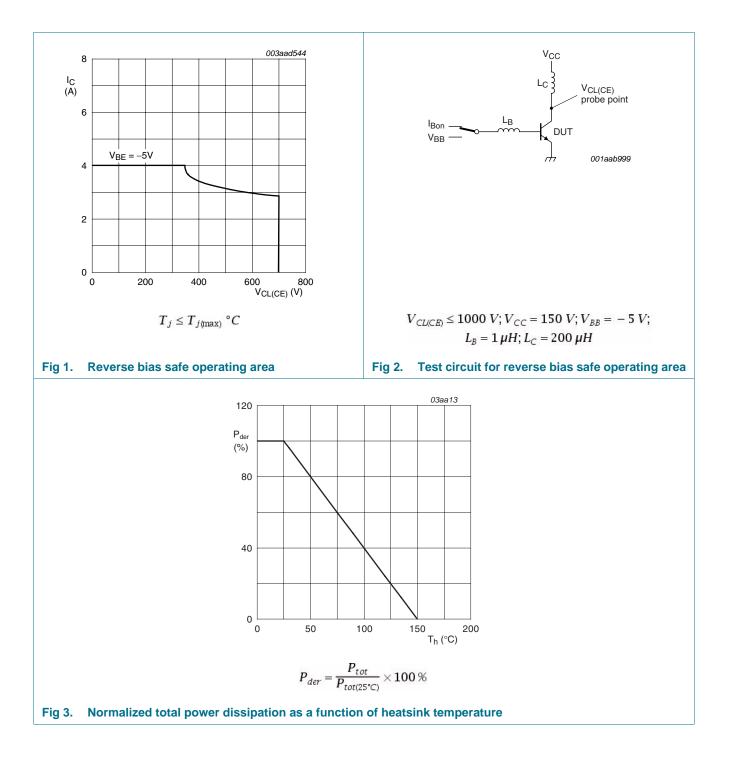
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CESM}	collector-emitter peak voltage	$V_{BE} = 0 V$	-	700	V
V _{CBO}	collector-base voltage	I _E = 0 A	-	700	V
V _{CEO}	collector-emitter voltage	I _B = 0 A	-	400	V
I _C	collector current	DC; see Figure 1; see Figure 2; see Figure 4	-	4	А
I _{CM}	peak collector current	see Figure 4; see Figure 1; see Figure 2	-	8	А
I _B	base current	DC	-	2	А
I _{BM}	peak base current		-	4	А
P _{tot}	total power dissipation	T _{mb} ≤ 25 °C; see <u>Figure 3</u>	-	75	W
T _{stg}	storage temperature		-65	150	°C
Tj	junction temperature		-	150	°C

PHD13005 Product data sheet

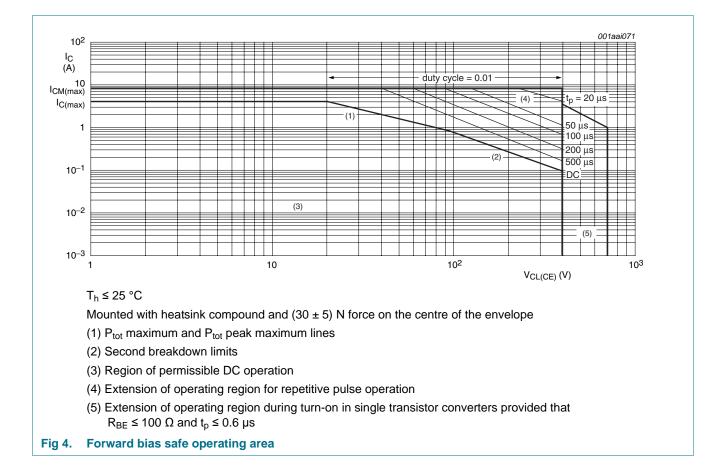
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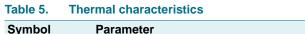
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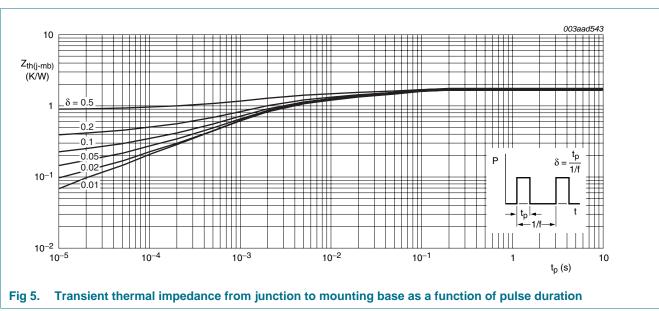


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Thermal characteristics 5.

Table 5.	mermai characterístics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-mb)}	thermal resistance from junction to mounting base	see Figure 5	-	-	1.67	K/W
R _{th(j-a)}	thermal resistance from junction to ambient	in free air	-	60	-	K/W





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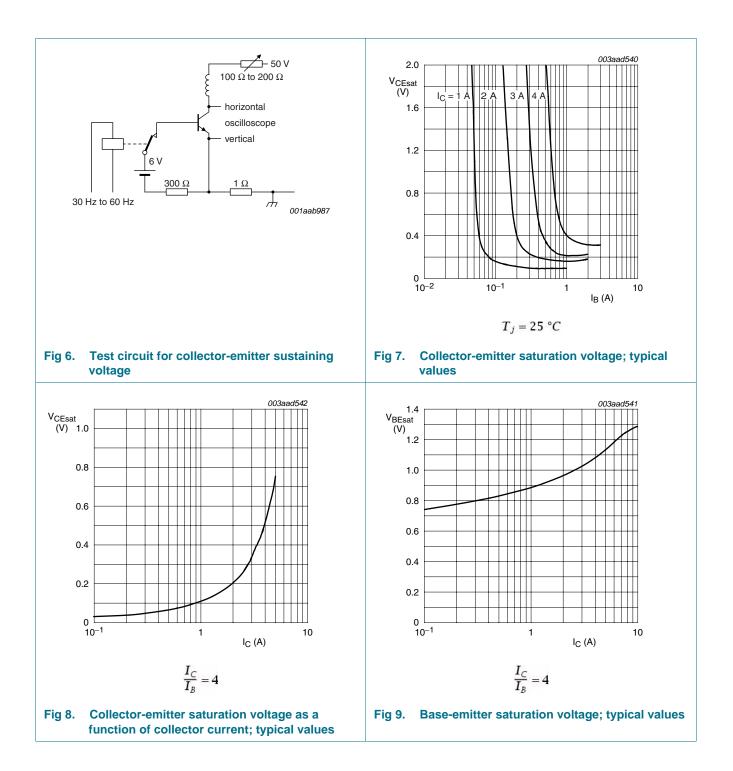
6. Characteristics

Table 6.	Characteristics					
Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
Static cha	aracteristics					
I _{CES}	collector-emitter cut-off	$V_{BE} = 0 \text{ V}; V_{CE} = 700 \text{ V}; T_j = 100 ^{\circ}\text{C}$	<u>[1]</u> _	-	5	mA
current	$V_{BE} = 0 V; V_{CE} = 700 V$	<u>[1]</u> _	-	1	mA	
I _{CBO}	collector-base cut-off current	$V_{CB} = 700 \text{ V}; \text{ I}_{E} = 0 \text{ A}$	<u>[1]</u> _	-	1	mA
I _{CEO}	collector-emitter cut-off current	$V_{CE} = 400 \text{ V}; \text{ I}_{B} = 0 \text{ A}$	<u>[1]</u> _	-	0.1	mA
I _{EBO}	emitter-base cut-off current	$V_{EB} = 9 V; I_C = 0 A$	-	-	10	mA
V _{CEOsus}	collector-emitter sustaining voltage	$I_B = 0 \text{ A}; I_C = 10 \text{ mA}; L_C = 25 \text{ mH};$ see <u>Figure 6</u> ; see <u>Figure 15</u>	400	-	-	V
V _{CEsat}	collector-emitter saturation voltage	$I_{C} = 1.0 \text{ A}; I_{B} = 0.2 \text{ A}; \text{ see } \frac{\text{Figure 7}}{\text{Figure 8}};$	-	0.1	0.5	V
		$I_C = 2.0 \text{ A}; I_B = 0.5 \text{ A}; \text{ see } \frac{\text{Figure 7}}{\text{Figure 8}};$	-	0.2	0.6	V
		$I_C = 4.0 \text{ A}; I_B = 1.0 \text{ A}; \text{ see } \frac{\text{Figure 7}}{\text{Figure 8}};$	-	0.3	1	V
V _{BEsat}	base-emitter saturation voltage	$I_{C} = 2.0 \text{ A}; I_{B} = 0.5 \text{ A}; \text{ see } \frac{\text{Figure 9}}{100000000000000000000000000000000000$	-	0.92	1.6	V
		$I_{C} = 1.0 \text{ A}; I_{B} = 0.2 \text{ A}; \text{ see } \frac{\text{Figure 9}}{100000000000000000000000000000000000$	-	0.85	1.2	V
V _F	forward voltage	I _F = 2.0 A	-	1.04	1.5	V
h _{FE}	DC current gain	I_{C} = 1.0 A; V_{CE} = 5 V; see <u>Figure 10</u>	12	20	40	
		I_C = 2.0 A; V_{CE} = 5 V; see <u>Figure 10</u>	10	17	28	
Dynamic	characteristics					
t _s stor	storage time	$I_{C} = 2.0 \text{ A}; I_{Bon} = 0.4 \text{ A}; V_{BB} = -5 \text{ V};$ $L_{B} = 1 \mu\text{H}; \text{ inductive load};$ see <u>Figure 11</u> ; see <u>Figure 12</u>	-	1.2	2	μs
		$I_{C} = 2.0 \text{ A}; I_{Bon} = 0.4 \text{ A}; I_{Boff} = -0.4 \text{ A};$ $R_{L} = 75 \Omega; \text{ resistive load};$ see <u>Figure 13</u> ; see <u>Figure 14</u>	-	2.7	4	μs
		$\label{eq:IC} \begin{array}{l} I_C = 2.0 \text{ A}; \ I_{Bon} = 0.4 \text{ A}; \ V_{BB} = -5 \text{ V}; \\ I_B = 1 \ \mu\text{H}; \ T_j = 100 \ ^\circ\text{C}; \ \text{inductive load}; \\ \text{see } \underline{\text{Figure 11}}; \ \text{see } \underline{\text{Figure 12}} \end{array}$	-	1.4	4	μs
t _f fa	fall time	$\begin{split} I_{C} &= 2.0 \text{ A}; I_{Bon} = 0.4 \text{ A}; I_{Boff} = -0.4 \text{ A}; \\ R_{L} &= 75 \Omega; \text{ resistive load}; \\ \text{see } \underline{\text{Figure 13}}; \text{ see } \underline{\text{Figure 14}} \end{split}$	-	0.3	0.9	μs
		$\begin{split} I_C &= 2.0 \text{ A}; \ I_{Bon} = 0.4 \text{ A}; \ V_{BB} = -5 \text{ V}; \\ L_B &= 1 \ \mu\text{H}; \ T_j = 100 \ ^\circ\text{C}; \ \text{inductive load}; \\ \text{see } \underline{\text{Figure 11}}; \ \text{see } \underline{\text{Figure 12}} \end{split}$	-	0.16	0.9	μs
		I_{C} = 2.0 A; I_{Bon} = 0.4 A; V_{BB} = -5 V; L_{B} = 1 µH; inductive load; see <u>Figure 11</u> ; see <u>Figure 12</u>	-	0.1	0.5	μs

[1] measured with half-sine wave voltage (curve tracer)

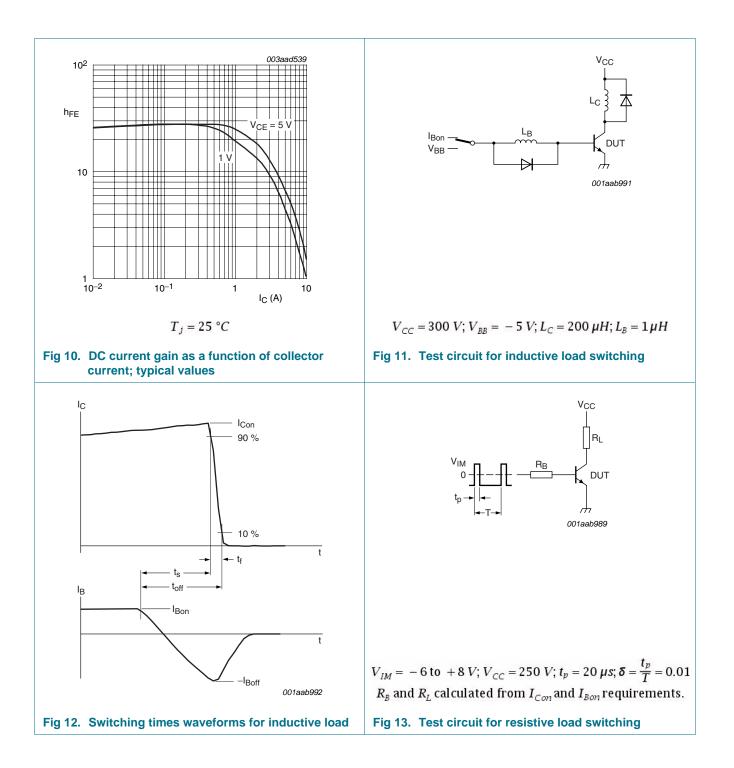
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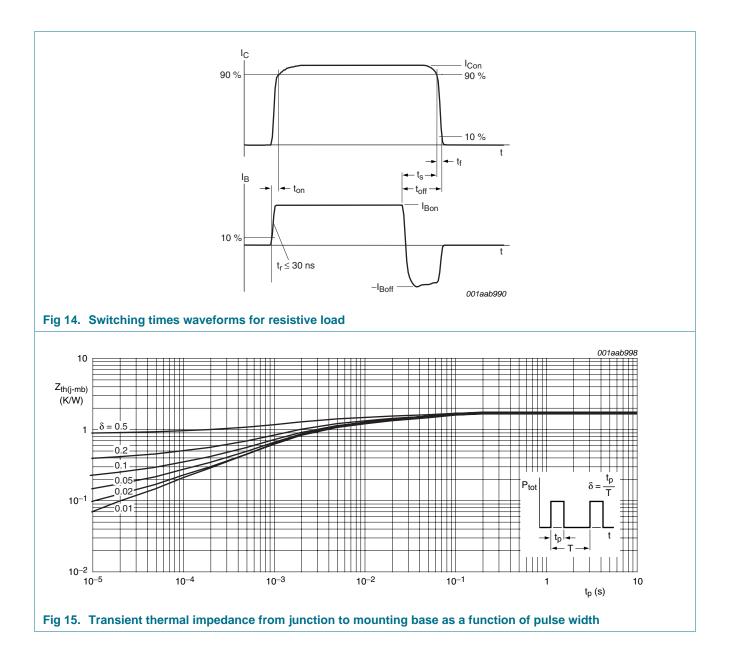
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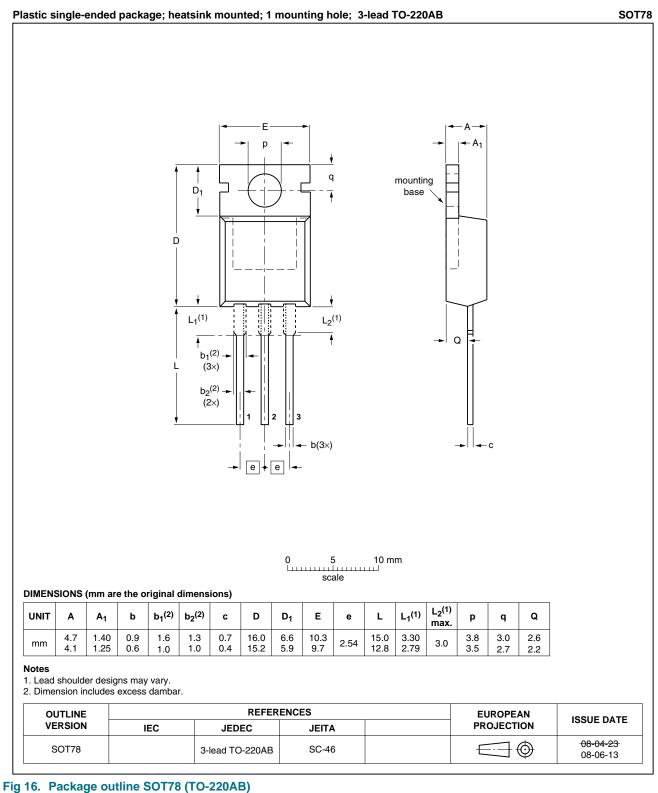
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Package outline 7.



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8. Revision history

Table 7. Revisio	n history			
Document ID	Release date	Data sheet status	Change notice	Supersedes
PHD13005 v.2	20100729	Product data sheet	-	PHD13005 v.1
Modifications:	 Various chang 	es to content.		
PHD13005 v.1	20100520	Product data sheet	-	-

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9. Legal information

9.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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